

# MA3SD05F

## Silicon epitaxial planar type

For high frequency rectification

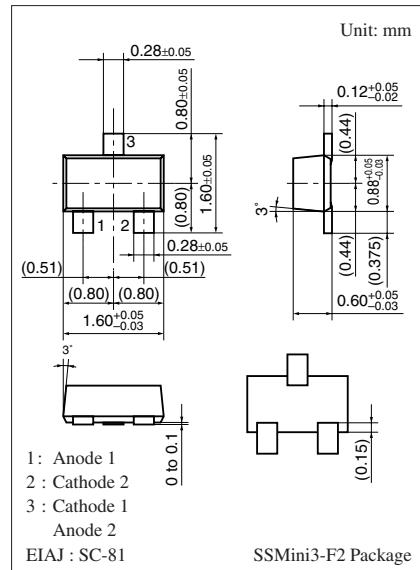
### ■ Features

- Series connection
- High-density mounting is possible

### ■ Absolute Maximum Ratings $T_a = 25^\circ\text{C}$

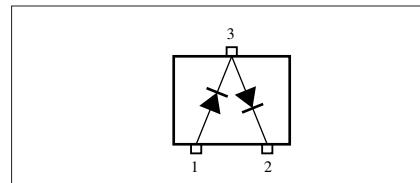
Parameter	Symbol	Rating	Unit
Reverse voltage	$V_R$	45	V
Maximum peak reverse voltage	$V_{RM}$	45	V
Forward current	$I_F$	100	mA
Series	75		
Peak forward current	$I_{FM}$	300	mA
Series	225		
Non-repetitive peak forward surge current *	$I_{FSM}$	1	A
Series	0.75		
Junction temperature	$T_j$	125	$^\circ\text{C}$
Storage temperature	$T_{stg}$	-55 to +125	$^\circ\text{C}$

Note) \*: The peak-to-peak value in one cycle of 50 Hz sine wave (non-repetitive)



Marking Symbol: M5C

### Internal Connection



### ■ Electrical Characteristics $T_a = 25^\circ\text{C} \pm 3^\circ\text{C}$

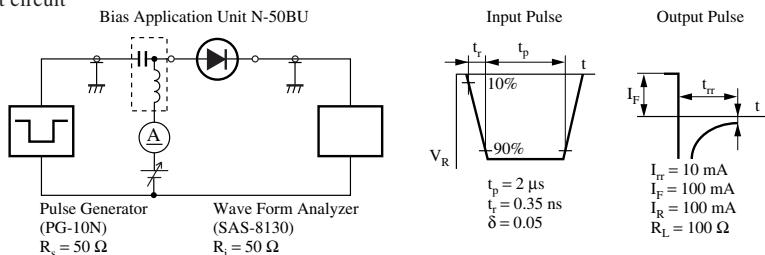
Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Forward voltage	$V_F$	$I_F = 100 \text{ mA}$		0.54	0.60	V
Reverse current	$I_R$	$V_R = 40 \text{ V}$			5	$\mu\text{A}$
Terminal capacitance	$C_t$	$V_R = 0 \text{ V}, f = 1 \text{ MHz}$		12	18	pF
Reverse recovery time *	$t_{rr}$	$I_F = I_R = 100 \text{ mA}$ $I_{rr} = 10 \text{ mA}, R_L = 100 \Omega$		2.0		ns

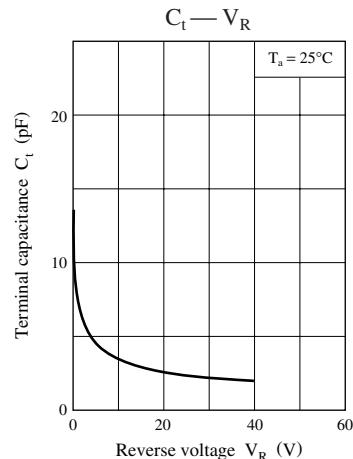
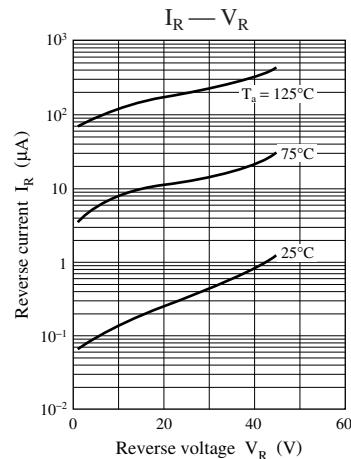
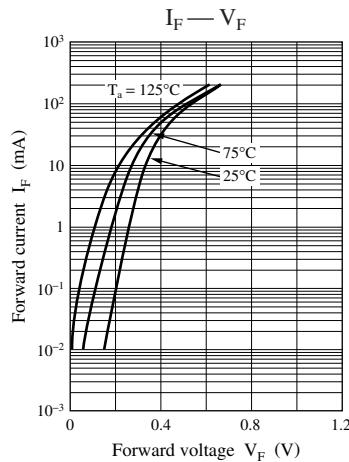
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

2. This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.

3. Absolute frequency of input and output is 250 MHz

4. \*:  $t_{rr}$  measurement circuit





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